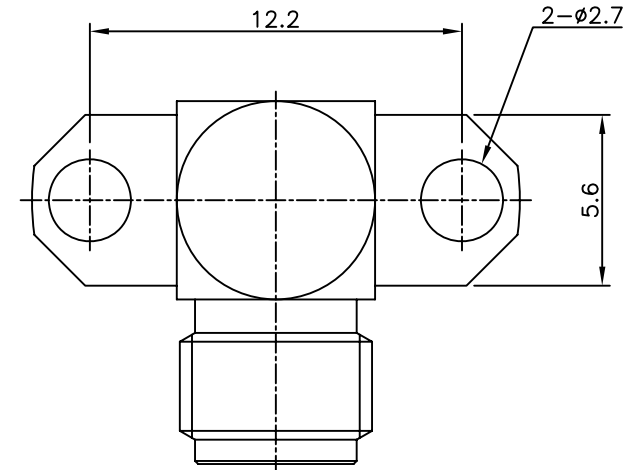
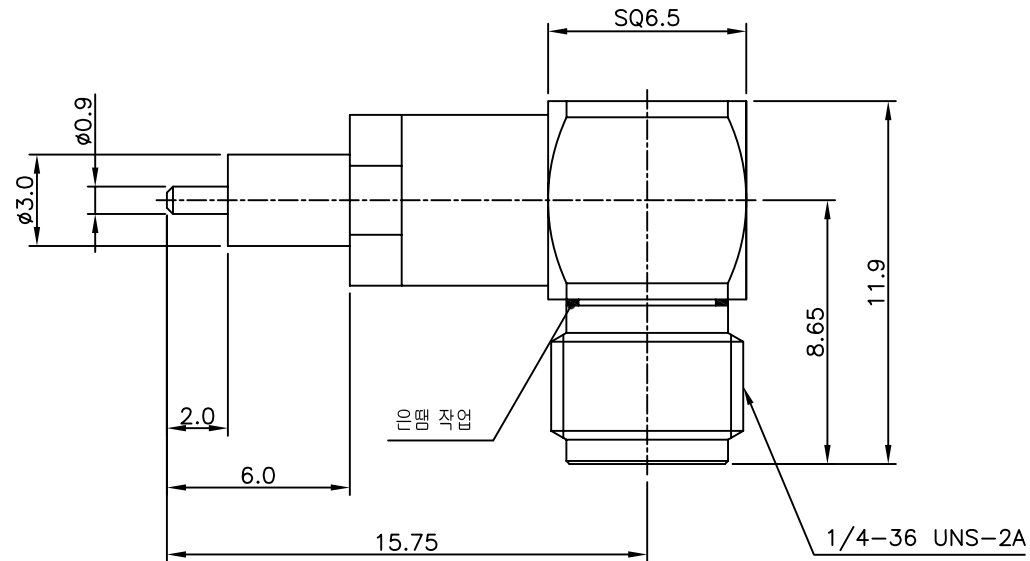


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019.12.03.



6	COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00042-5/3
5	INSULATOR	1	TEFLON		DIN03104-N/1
4	INSULATOR	1	TEFLON		DIN03025-N/1
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT04093-5/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT00151-5/2
1	1-2 BODY(B)	1	MBsBD C3604BD-F	Nickel Plate	DBB00072-5/6 DBD00206-1/1 DBD00223-1/3
	1-1 BODY(A)	1	MBsBD C3604BD-F	Nickel Plate	
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2019. 12. 03.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JL-2H
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	UNIT	A4 DWG NO. CN03812-7/3 REVISION I R SHEET 1 of 1
		4/1	mm	